# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

# **CONVEYING PARTY DATA**

Name	Execution Date
Erich Syri	07/03/2007
Gerold Gruendler	07/03/2007
Juergen Hoegerl	07/03/2007
Thomas Killer	07/03/2007
Volker Strutz	07/03/2007

### **RECEIVING PARTY DATA**

Name:	Infineon Technologies AG	
Street Address:	Am Campeon 1 - 12	
City:	Neubiberg	
State/Country:	GERMANY	
Postal Code:	85579	

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11759977

# **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 3002.0224C

NAME OF SUBMITTER: Andrew J. Aldag

REEL: 020635 FRAME: 0923

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Total Attachments: 2

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> PATENT REEL: 020635 FRAME: 0924

#### ASSIGNMENT

For good and valuable consideration, WE, Erich SYRI, a citizen of Germany, residing at Am Osthang 8, 93173 Wenzenbach, Germany, Gerold GRUENDLER, a citizen of Germany, residing at Schopperplatz 5a, 93059 Regensburg, Germany, Juergen HOEGERL, a citizen of Germany, residing at Hofweg 28a, 93053 Regensburg, Germany, Thomas KILLER, a citizen of Germany, residing at Regensburgerstr. 25a, 93155 Hohenschambach, Germany and Volker STRUTZ, a citizen of Germany, residing at Wiedmannstr. 22, 93105 Tegernheim, Germany, hereinafter collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at Am Campeon 1-12, 85579 Neubiberg, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on June 8, 2007 as US. Application Serial No. 11/759,977,

entitled: Semiconductor Device Comprising a Plastic Housing, a Semiconductor Chip and an Interposer, and Method for Producing the Same

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements an the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:

Erich SYRI

DATE:

mly-03-2007

SIGNATURE:	Gerold GRUENDLER	REF NO. FIN 693 PCT/US hs/jf O.C. REF NO. 3002.0224C  DATE: JULY -03-2007
SIGNATURE:	Mergen MOEGERL	_ DATE: July -03-2007
SIGNATURE:	Ma Ilana Thomas KILLER	_ DATE: _3.07.2007
Sįgnature:  .	Volker STRUTZ	DATE: July - 03 - 2007